

GH5RA1HA3C

(Under development)

■ Features

- (1) High power output (pulse MAX. 144mW)
 - (2) For $\times 16$ speed CD-R, $\times 40$ speed CD-ROM
(With built-in MIN. 45MHz OPIC[®])
 - (3) Sample hold system (tracking method)
 - (4) High coupling efficiency
The ellipticity ($\theta_{\perp}/\theta_{//}$) is close to 1.
 - (5) $\phi 4.8$ mm thickness
 - (6) With built-in beam splitter and diffraction grating
- [®]OPIC : (Optical IC) is a trademark of SHARP Corporation.
An OPIC consists of a light-detecting element and a signal-processing circuit integrated onto a single chip.

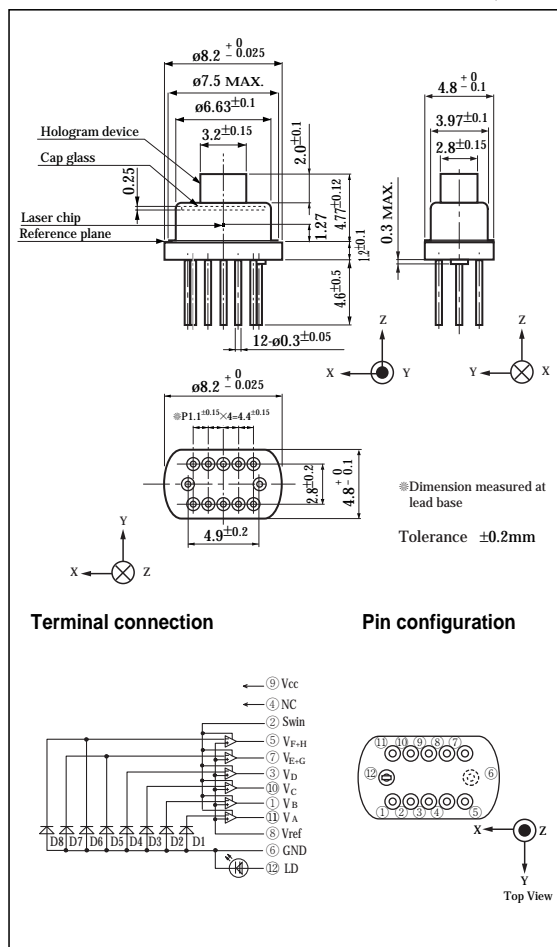
■ Applications

- (1) CD-R drives
- (2) CD-RW drives

Sampling Hold Method, High Power Output Hologram Laser for X16 Speed CD-R Drive

■ Outline Dimensions

(Unit : mm)



■ Absolute Maximum Ratings

(T_C=25°C)

Parameter	Symbol	Rating	Unit
① Optical power output	P _{HC}	101	mW
② Optical power output (pulse)	P _{HP}	144	mW
Reverse voltage	V _R	2	V
OPIC supply voltage	V _{CC}	6	V
Operating temperature	T _{opr}	0 to +60	°C
Storage temperature	T _{stg}	-40 to +85	°C
Soldering temperature	T _{sold}	260	°C

① Output power from hologram laser Equivalent to 120mW (CW) from cap glass

② Output power from hologram laser Equivalent to 160mW (pulse) from cap glass (pulse width : 0.5μs, Duty : 50%)

③ Case temperature ④ At the position of 1.6mm from the lead base (Within 5s)

SHARP

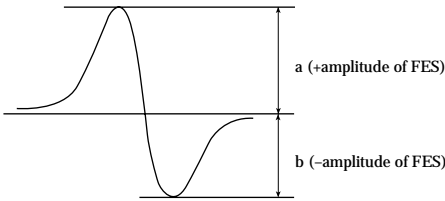
Electro-optical Characteristics

(Tc=25°C)

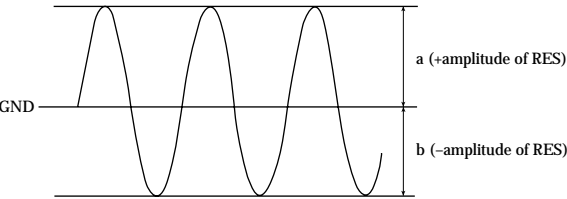
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
① Focal offset	DEF	Collimated lens output power 1.5mW, High gain	-0.7	-	+0.7	μm
② Focal error symmetry	BFES	Collimated lens output power 1.5mW, High gain	-25	-	+25	%
③ Radial error balance	BRES	Collimated lens output power 1.5mW, High gain	-25	-	+25	%
④ RF output amplitude	V _{RFH}	Collimated lens output power 1.5mW, High gain	0.32	0.47	0.62	V
⑤ FES output amplitude	V _{FES}	Collimated lens output power 1.5mW, High gain	0.17	0.3	0.47	V
⑥ RES output amplitude	V _{RES}	Collimated lens output power 1.5mW, High gain	0.04	0.1	0.15	V
⑦ Main spot balance	MSB	Collimated lens output power 1.5mW, High gain	80	(100)	120	%
⑧ Sub spot balance	SSB	Collimated lens output power 1.5mW, High gain	80	(100)	120	%
Jitter	JIT	Collimated lens output power 1.5mW, High gain	-	-	23	ns
⑨ Strain of RF signal shape	RF _h	Collimated lens output power 1.5mW, High gain	-	-	230	%

① Distance between FES=0 and jitter minimum point

② (a-b) / (a+b)



③ $\frac{a-b}{2 \times (a+b)}$



④ Amplitude of V_A+V_B+V_C+V_D (focal servo ON, radial servo ON)

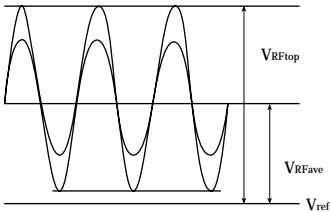
⑤ V_B-V_A (Focal vibration)

⑥ Amplitude of (V_C-V_D)-k₁(V_E+G-V_F+H). k₁=(V_C+V_D)/(V_E+G+V_F+H)=1
When tracking servo is ON, (V_C-V_D)-k₁(V_E+G-V_F+H)+α should be 0.

⑦ (V_A+V_B) / (V_C+V_D)

⑧ V_C/V_D

⑨ V_{RFtop}/V_{RFave}



Electro-optical Characteristics of Laser Diode

(T_C=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Threshold current		I _{th}	—	-	30	41	mA
Operating current		I _{op}	Po=100mW	-	130	155	mA
Operating voltage		V _{op}	Po=100mW	-	2.2	2.5	V
Wavelength		λ _p	Po=100mW	773	784	797	nm
Differential efficiency		η _d	$\frac{70\text{mW}}{I(100\text{mW})-I(30\text{mW})}$	0.7	0.85	1.2	mW/mA
Stability of differential efficiency		Δη _d	Po=10 to 150mW	-	-	40	%
Half intensity angle	Parallel	θ//	Po=100mW	7.5	9	10.5	°
	Perpendicular	θ⊥		14.5	17	19.5	°
Emission characteristics	Parallel	ø//		-2	-	+2	°
	Perpendicular	ø⊥		-3	-	+3	°
Beam shift		Δø//	ø//(100mW)-ø//(3mW)	-1	-	+1	°
Kink		K-LI1	Po=10 to 150mW	0.988	-	-	%
		K-LI2	P1=30mW, P2=90mW, P3=150mW	-	-	15	%

Electro-optical Characteristics of OPIC for Signal Detection^{※10}

(T_C=25°C, V_{CC}=5V, V_{ref}=2.1V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	※11 Segment
Supply current	I _{CC1}	High gain, Gain switching SW=H	-	20	25	mA	
	I _{CC2}	Low gain, Gain switching SW=L	-	30	35	mA	
※12 Output off-set voltage	V _{od}	Common to high/low gain, No light	-25	2	+25	mV	A, B
Off-set voltage difference, Gain switching	ΔV _{od}	Common to high/low gain	-30	-	+30	mV	A, B

※10 0.1μF or more capacitor should be added between OPIC power supply terminal and GND, V_{ref} terminal and GND. (at the position of 5mm or less from the lead base)

※11 Applicable divisions correspond to output terminals.

A : V_A, V_B, V_C, V_D

B : V_{E+G}, V_{F+H}

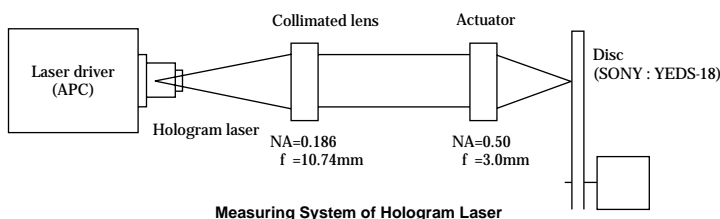
※12 Difference from V_{ref}

Electro-optical Characteristics of Hologram Laser (Design Standard)^{※1}

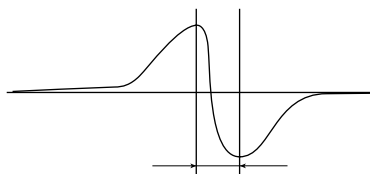
(T_C=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
※2 Focal error signal capture range	-	—	-	14	-	μm
Focal error signal sensitivity	-	—	-	13	-	%/μm

※1



※2



* These parameters are not guaranteed performance, but general specifications of each optical element which makes up a hologram laser.

■ Optical Characteristics of Hologram Device (Design Standard*)

(T_C=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Hologram diffraction efficiency	0 th	-	$\lambda=780\text{nm}$	77	82	-	%
	$\pm 1\text{st}$	-		6	7	9	%
Hologram diffraction angle	D1,D2	-	$\lambda=780\text{nm}$	-	21.1	-	°
	Except D1,D2	-		-	26.4	-	°
Grating diffraction efficiency		-	0:1	6.7	9	12.4	-
Grating diffraction angle		-	$\lambda=780\text{nm}$	-	2.8	-	°

■ Electro-optical Characteristics of Laser Diode (Design Standard*)

(T_C=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Misalignment position		Δx	—	-80	-	+80	μm
		Δy		-80	-	+80	μm
		Δz		-80	-	+80	μm
⑧ Reflectivity of LD rear facet		R _r	—	85	-	-	%

■ Electro-optical Characteristics of OPIC for Signal Detection (Design Standard*)

(T_C=25°C, V_{CC}=5V, V_{ref}=2.1V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	④ Segment
Supply voltage	V _{CC}	—	4.75	5	5.25	V	
Reference voltage	V _{ref}	—	2.00	2.1	2.21	V	
⑥,7,8,9 Response frequency	f _{cm}	Common to high/low gain, -3dB	45	60	-	MHz	A
	f _{csH}	Sub amp, High gain, -3dB	1	2	-	MHz	B
	f _{csL}	Sub amp, Low gain, -3dB	16	24	-	MHz	B
⑤,6,8,9 Peaking level	V _{pk2}	Common to high/low gain f=0.1 to 50MHz	-	-	3	dB	A
⑨ Noise level	f _{nm}	High gain, 50 Ω end BW=30kHz, f=36MHz	-	-74	-70	dBm	A
Sensitivity 1	R _{m1}	Main amp, High gain	9	12	15	mV/ μW	A
Sensitivity 2	R _{m2}	Main amp, Low gain	2.25	3	3.75	mV/ μW	A
Sensitivity 3	R _{m3}	Sub amp, High gain	36	48	60	mV/ μW	B
Sensitivity 4	R _{m4}	Sub amp, Low gain	9	12	15	mV/ μW	B
Thermal drift of sensitivity	R _{sm} /T	Common to high/low gain	-	4 200	-	ppm/°C	A, B
Thermal drift of offset voltage	V _{od} /T	Common to high/low gain, No light	-	300	-	$\mu\text{V}/^{\circ}\text{C}$	A, B
Thermal drift of offset voltage 1	V _{os1} /T	Main amp, High gain, No light	-	30	-	$\mu\text{V}/^{\circ}\text{C}$	A
Thermal drift of offset voltage 2	V _{os2} /T	Main amp, Low gain, No light	-	25	-	$\mu\text{V}/^{\circ}\text{C}$	A
Thermal drift of offset voltage 3	V _{os3} /T	Sub amp, High gain, No light	-	30	-	$\mu\text{V}/^{\circ}\text{C}$	B
Thermal drift of offset voltage 4	V _{os4} /T	Sub amp, Low gain, No light	-	25	-	$\mu\text{V}/^{\circ}\text{C}$	B
Thermal drift of offset voltage 5	V _{os5} /T	Between main-sub amp, High gain, No light	-	100	-	$\mu\text{V}/^{\circ}\text{C}$	A-B
Thermal drift of offset voltage 6	V _{os6} /T	Between main-sub amp, Low gain, No light	-	75	-	$\mu\text{V}/^{\circ}\text{C}$	A-B
Stabilization time at gain switching	t _{str2}	Common to high/low gain, time for $\pm 3\text{mV}$	-	-	25	μs	A, B
Settling time	testm	500mV \rightarrow 10mV	f=6.9MHz	30	-	ns	A
	testS	Low gain, fall time		90	-	ns	B
Maximum output voltage	V _{omax}	Common to high/low gain, V _{ref} reference	1	-	-	V	A, B

③ Sampling rate is 1pc./reflection membrane formation process lot

④ Applicable divisions correspond to output terminals.

A : V_A, V_B, V_C, V_DB : V_{E+G}, V_{F+H}⑤ Difference from V_{ref}⑥ Light source is a laser diode of $\lambda=780\text{nm}$.

⑦ -3dB level (0dB level is taken for output level when f=0.1MHz)

⑧ 10 μW of DC light is applied to the center of each photodiode, and 4 μW of AC light is irradiated. BW=10kHz⑨ 5k Ω of resistor and 10pF of capacitor should be connected in parallel between output terminal and V_{ref} terminal.

* These parameters are not guaranteed performance, but general specifications of each optical element which makes up a hologram laser.

• Please refer to the chapter "Handling Precautions"

SHARP

NOTICE

The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.

Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.

Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:

(i) The devices in this publication are designed for use in general electronic equipment designs such as:

- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.

If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Control Law of Japan, it is necessary to obtain approval to export such SHARP devices.

This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.

Contact and consult with a SHARP representative if there are any questions about the contents of this publication.